IMEC306.001AUS

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

Szlufcik et al.

NON 0 3 JOUR

Appl. No.

10/609,015

Filed

June 27, 2003

For

SEMICONDUCTOR ETCHING

PASTE AND THE USE THEREOF

FOR LOCALIZED ETCHING OF

SEMICONDUCTOR

SUBSTRATES

Examiner

Vinh, L.

Group Art Unit

1765

CERTIFICATE OF MAILING

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

October 30, 2006

Rose M. Thiessen, Reg. No. 40,202

AMENDMENT

Mail Stop Amendment

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed May 2, 2006, Applicants respectfully request that the Examiner enter the following amendments and consider the following remarks.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.